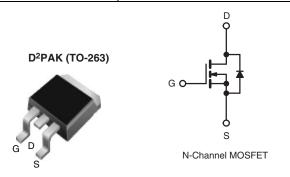
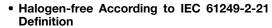
Vishay Siliconix

E Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max. 700				
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V	0.145		
Q _g max. (nC) 122		2		
Q _{gs} (nC) 21				
Q _{gd} (nC)	37			
Configuration Single				



FEATURES





HALOGEN FREE

- Low Figure-of-Merit (FOM) Ron x Qg
- Low Input Capacitance (Ciss)
- · Reduced Switching and Conduction Losses
- Ultra Low Gate Charge (Q_g)
- Avalanche Energy Rated (UIS)
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Server and Telecom Power Supplies
- Switch Mode Power Supplies (SMPS)
- Power Factor Correction Power Supplies (PFC)
- Lighting
 - High-Intensity Discharge (HID)
 - Fluorescent Ballast Lighting
- Industrial
 - Welding
 - Induction Heating
 - Motor Drives
 - Battery Chargers
 - Renewable Energy
 - Solar (PV Inverters)

ORDERING INFORMATION	
Package	D ² PAK (TO-263)
Lead (Pb)-free and Halogen-free	SiHB24N65E-GE3

ABSOLUTE MAXIMUM RATINGS (T	C = 20 0, um	OCC CLITCI WIL	· · · · · · · · · · · · · · · · · · ·			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	650		
Gate-Source Voltage			.,	± 20	V	
Gate-Source Voltage AC (f > 1 Hz)			V _{GS}	30		
Continuous Drain Current (T. – 150 °C)	V _{GS} at 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$	_	24		
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 100 °C	I _D -	16	Α	
Pulsed Drain Current ^a	I _{DM}	70				
Linear Derating Factor				2	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	508	mJ	
Maximum Power Dissipation	P_{D}	250	W			
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	°C	
Drain-Source Voltage Slope	$T_{J} = 1$	T _J = 125 °C		37	1//20	
Reverse Diode dV/dt ^d			dV/dt	11	V/ns	
Soldering Recommendations (Peak Temperature) for 10 s				300°	°C	
			-			

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 6 A.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, dI/dt = 100 A/ μ s, starting $T_J = 25$ °C.



Vishay Siliconix

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W		
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.5	C/VV		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		•					
Drain-Source Breakdown Voltage	V _{DS}	V _{GS}	= 0 V, I _D = 250 μA	650	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 250 μA	-	0.72	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} :	= V _{GS} , I _D = 250 μA	2	-	4	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V	-	-	± 100	nA
		V _{DS} :	= 650 V, V _{GS} = 0 V	-	-	1	
Zero Gate Voltage Drain Current	I_{DSS}	V _{DS} = 520 \	/, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 12 A	-	0.120	0.145	Ω
Forward Transconductance	9fs	V _D	_S = 8 V, I _D = 5 A	-	7.1	-	S
Dynamic		•					
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ f = 1 MHz		-	2740	-	pF
Output Capacitance	C _{oss}			-	122	-	
Reverse Transfer Capacitance	C _{rss}			-	4	-	
Total Gate Charge	Qg	V _{GS} = 10 V		-	81	122	nC
Gate-Source Charge	Q _{gs}			-	21	-	
Gate-Drain Charge	Q _{gd}	1		-	37	-	
Turn-On Delay Time	t _{d(on)}			-	24	48	
Rise Time	t _r	$V_{DD} = 520 \text{ V}, I_D = 24 \text{ A}, V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		-	84	126	ns
Turn-Off Delay Time	t _{d(off)}			-	70	105	
Fall Time	t _f			=.	69	104	
Gate Input Resistance	R_g	f = 1 MHz, open drain		-	0.68	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	24	
Pulsed Diode Forward Current	I _{SM}			-	-	96	- A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 24 A, V _{GS} = 0 V		-	-	1.2	V
Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = I _S = 24 A, dl/dt = 100 A/μs, V _R = 20 V		-	517	-	ns
Reverse Recovery Charge	Q _{rr}				9.7		μC
Reverse Recovery Current	I _{RRM}			-	30	-	Α

The information shown here is a preliminary product proposal, not a commercial product datasheet. Vishay Siliconix is not committed to produce this or any similar product. This information should not be used for design purposes, nor construed as an offer to furnish or sell such products.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

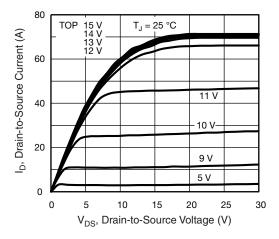


Fig. 1 - Typical Output Characteristics

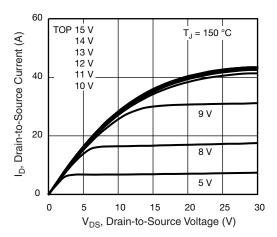


Fig. 2 - Typical Output Characteristics

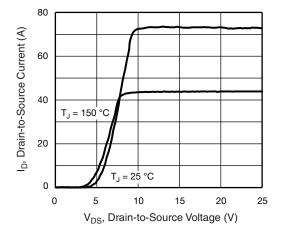


Fig. 3 - Typical Transfer Characteristics

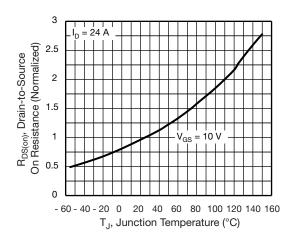


Fig. 4 - Normalized On-Resistance vs. Temperature

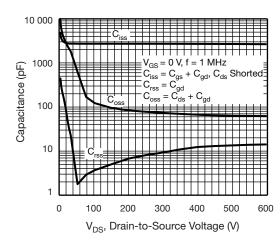


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

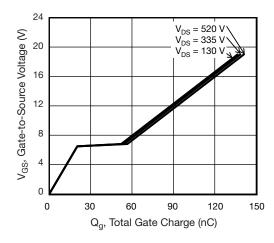


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



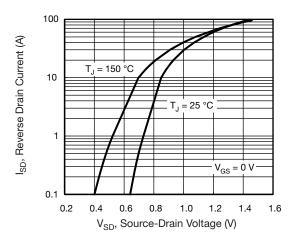


Fig. 7 - Typical Source-Drain Diode Forward Voltage

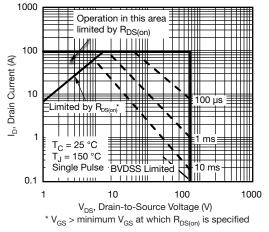


Fig. 8 - Maximum Safe Operating Area

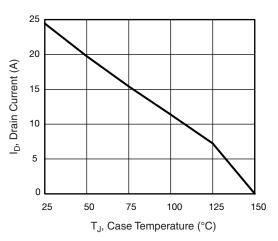


Fig. 9 - Maximum Drain Current vs. Case Temperature

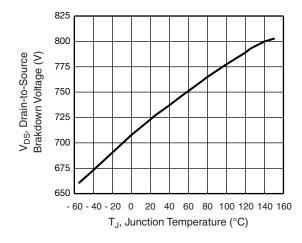


Fig. 10 - Temperature vs. Drain-to-Source Voltage

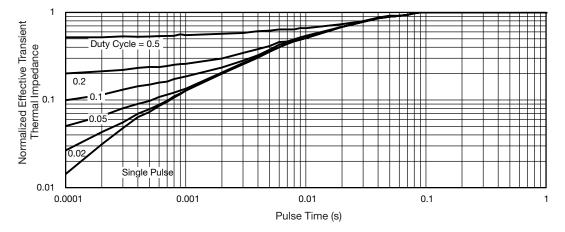


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



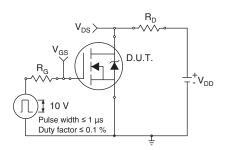


Fig. 12 - Switching Time Test Circuit

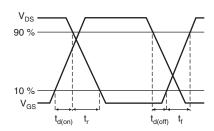


Fig. 13 - Switching Time Waveforms

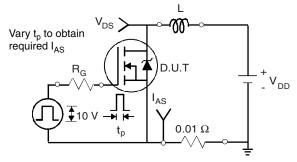


Fig. 14 - Unclamped Inductive Test Circuit

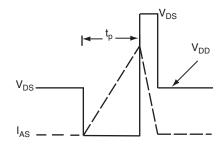


Fig. 15 - Unclamped Inductive Waveforms

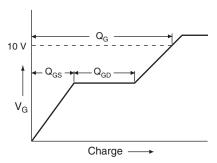


Fig. 16 - Basic Gate Charge Waveform

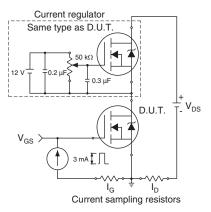
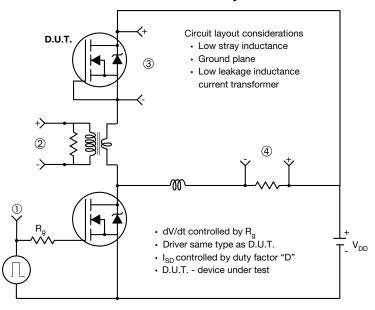


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



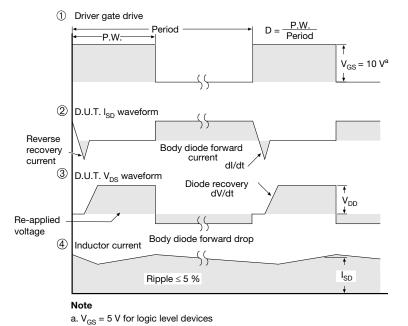


Fig. 18 - For N-Channel

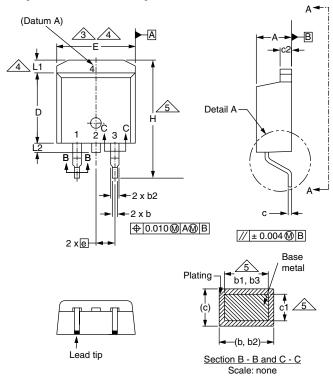
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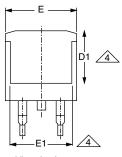


Vishay Siliconix

TO-263AB (HIGH VOLTAGE)







View A - A

	MILLIN	METERS	INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	4.06	4.83	0.160	0.190	
A1	0.00	0.25	0.000	0.010	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	
С	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	
c2	1.14	1.65	0.045	0.065	
D	8.38	9.65	0.330	0.380	

DIM. MIN. MAX. MIN. MAX. D1 6.86 - 0.270 - E 9.65 10.67 0.380 0.420 E1 6.22 - 0.245 - e 2.54 BSC 0.100 BSC H 14.61 15.88 0.575 0.625 L 1.78 2.79 0.070 0.110 L1 - 1.65 - 0.066 L2 - 1.78 - 0.070 L3 0.25 BSC 0.010 BSC		MILLIMETERS		INC	HES
E 9.65 10.67 0.380 0.420 E1 6.22 - 0.245 - e 2.54 BSC 0.100 BSC H 14.61 15.88 0.575 0.625 L 1.78 2.79 0.070 0.110 L1 - 1.65 - 0.066 L2 - 1.78 - 0.070	DIM.	MIN.	MAX.	MIN.	MAX.
E1 6.22 - 0.245 - e 2.54 BSC 0.100 BSC H 14.61 15.88 0.575 0.625 L 1.78 2.79 0.070 0.110 L1 - 1.65 - 0.066 L2 - 1.78 - 0.070	D1	6.86	-	0.270	-
e 2.54 BSC 0.100 BSC H 14.61 15.88 0.575 0.625 L 1.78 2.79 0.070 0.110 L1 - 1.65 - 0.066 L2 - 1.78 - 0.070	E	9.65	10.67	0.380	0.420
H 14.61 15.88 0.575 0.625 L 1.78 2.79 0.070 0.110 L1 - 1.65 - 0.066 L2 - 1.78 - 0.070	E1	6.22	-	0.245	i
L 1.78 2.79 0.070 0.110 L1 - 1.65 - 0.066 L2 - 1.78 - 0.070	е	2.54 BSC		0.100 BSC	
L1 - 1.65 - 0.066 L2 - 1.78 - 0.070	Н	14.61	15.88	0.575	0.625
L2 - 1.78 - 0.070	L	1.78	2.79	0.070	0.110
	L1	-	1.65	-	0.066
L3 0.25 BSC 0.010 BSC	L2	-	1.78	-	0.070
	L3	0.25 BSC		0.010	BSC
L4 4.78 5.28 0.188 0.208	L4	4.78	5.28	0.188	0.208

ECN: S-82110-Rev. A, 15-Sep-08

DWG: 5970

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.

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